



US00D864167S

(12) **United States Design Patent**
Wu

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(54) **EARPHONE**

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(**) Term: **15 Years**

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(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223; D24/174; 128/864, 865, 866;
181/129, 130, 135; 379/430, 431;
381/380, 381, 312, 322, 328, 371;
455/90.3
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 1/1016; H04R
5/033; H04R 5/0335; H04R 1/1091;
H04R 1/1083; A61F 11/06
See application file for complete search history.

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(57) **CLAIM**

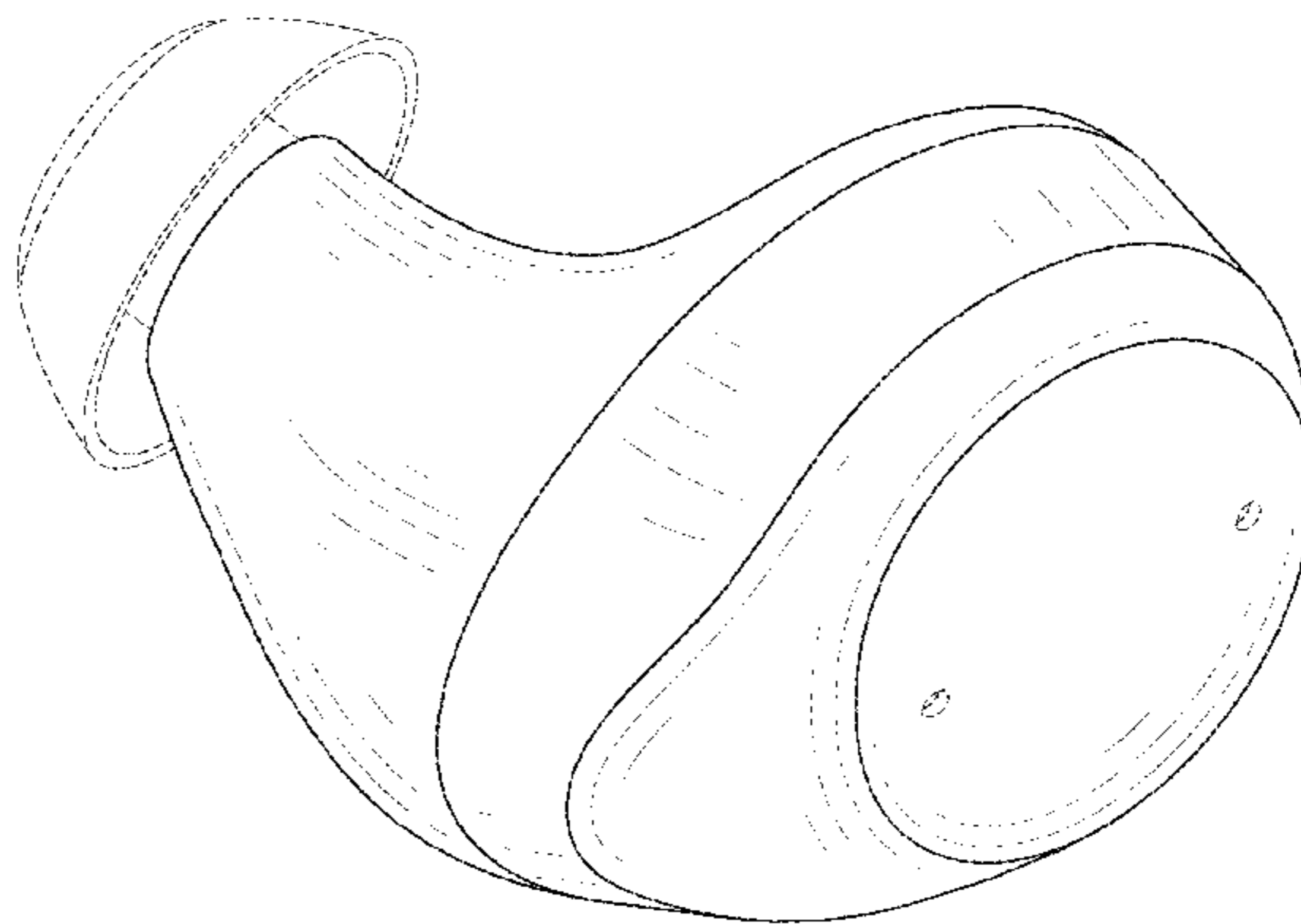
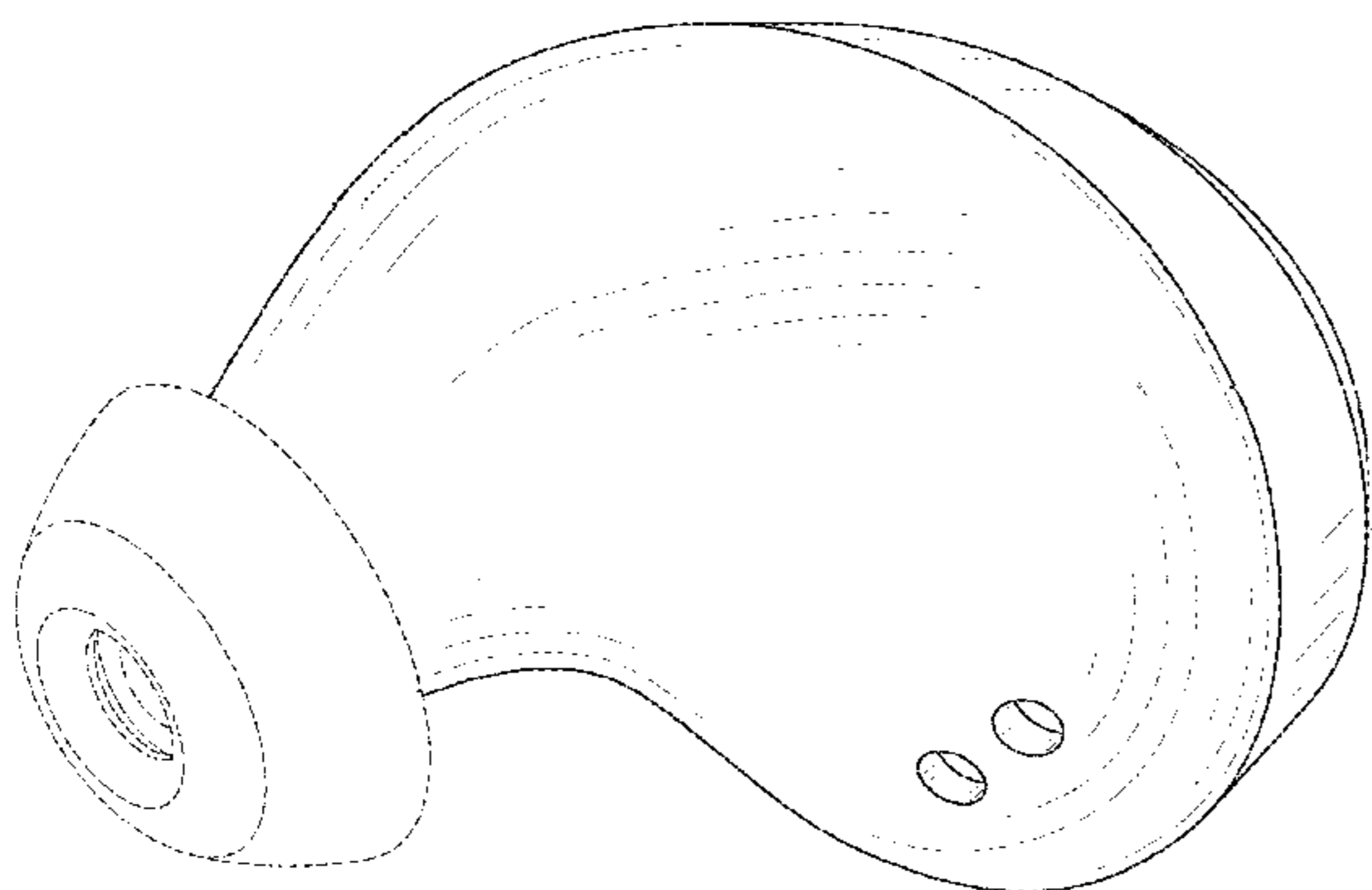
The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a first perspective view of an earphone showing the claimed new design;
FIG. 2 is a second perspective view thereof;
FIG. 3 is a front elevation view thereof;
FIG. 4 is a rear elevation view thereof;
FIG. 5 is a right side elevation view thereof;
FIG. 6 is a left side elevation view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.

The broken lines immediately adjacent to the claimed portions are boundaries, all other broken lines are environmental structures, and all the broken lines form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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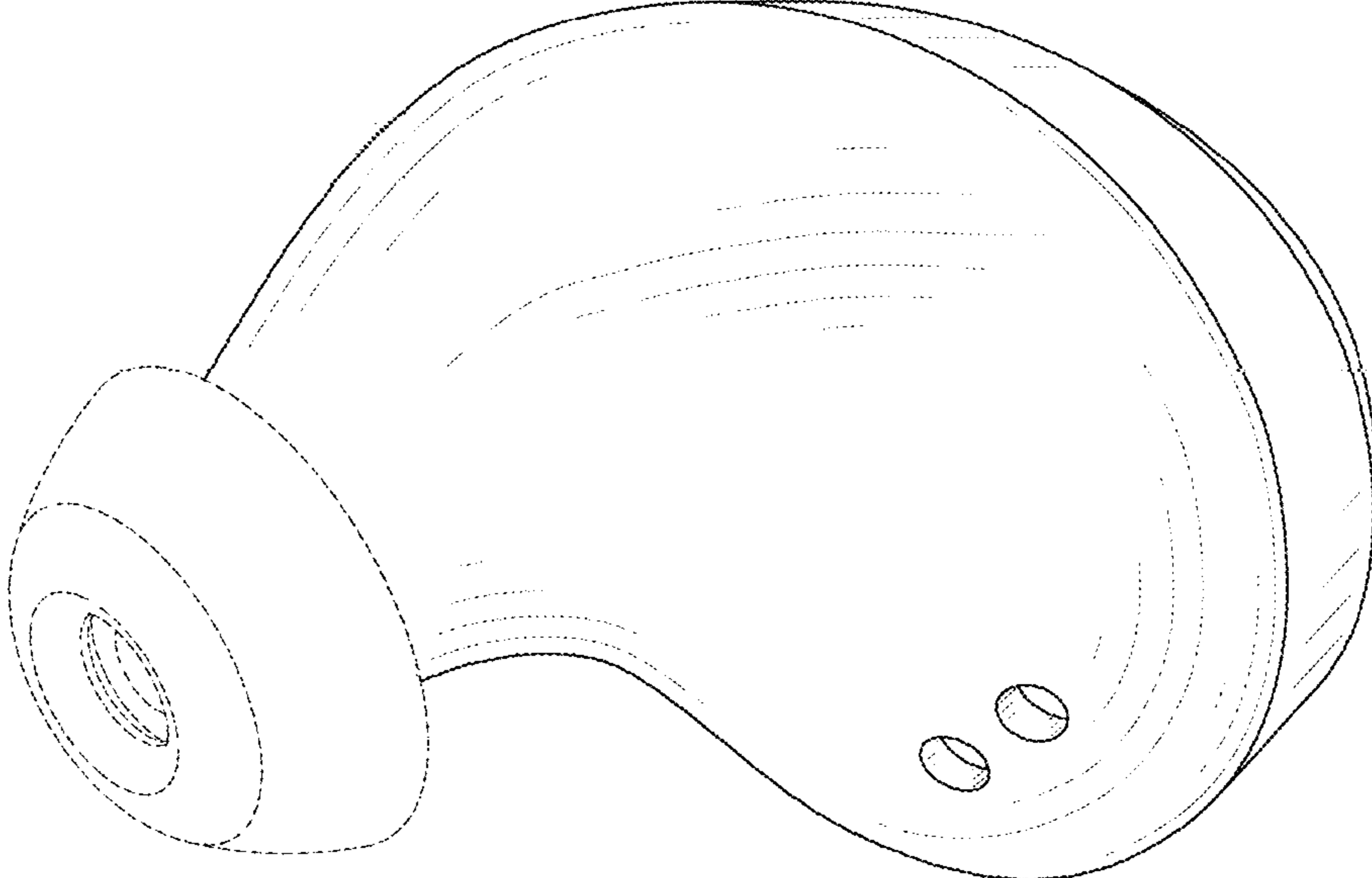


FIG. 1

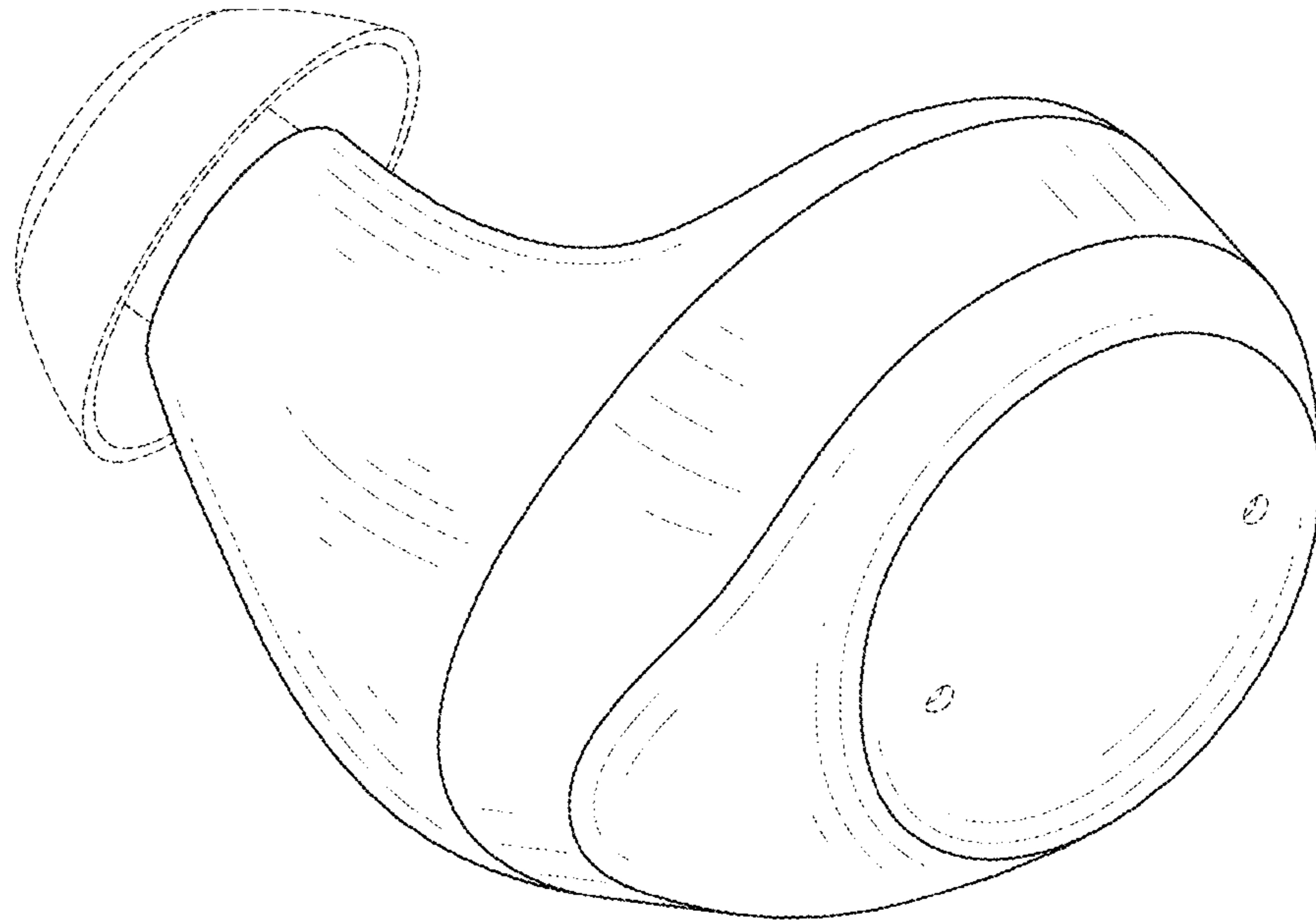


FIG. 2

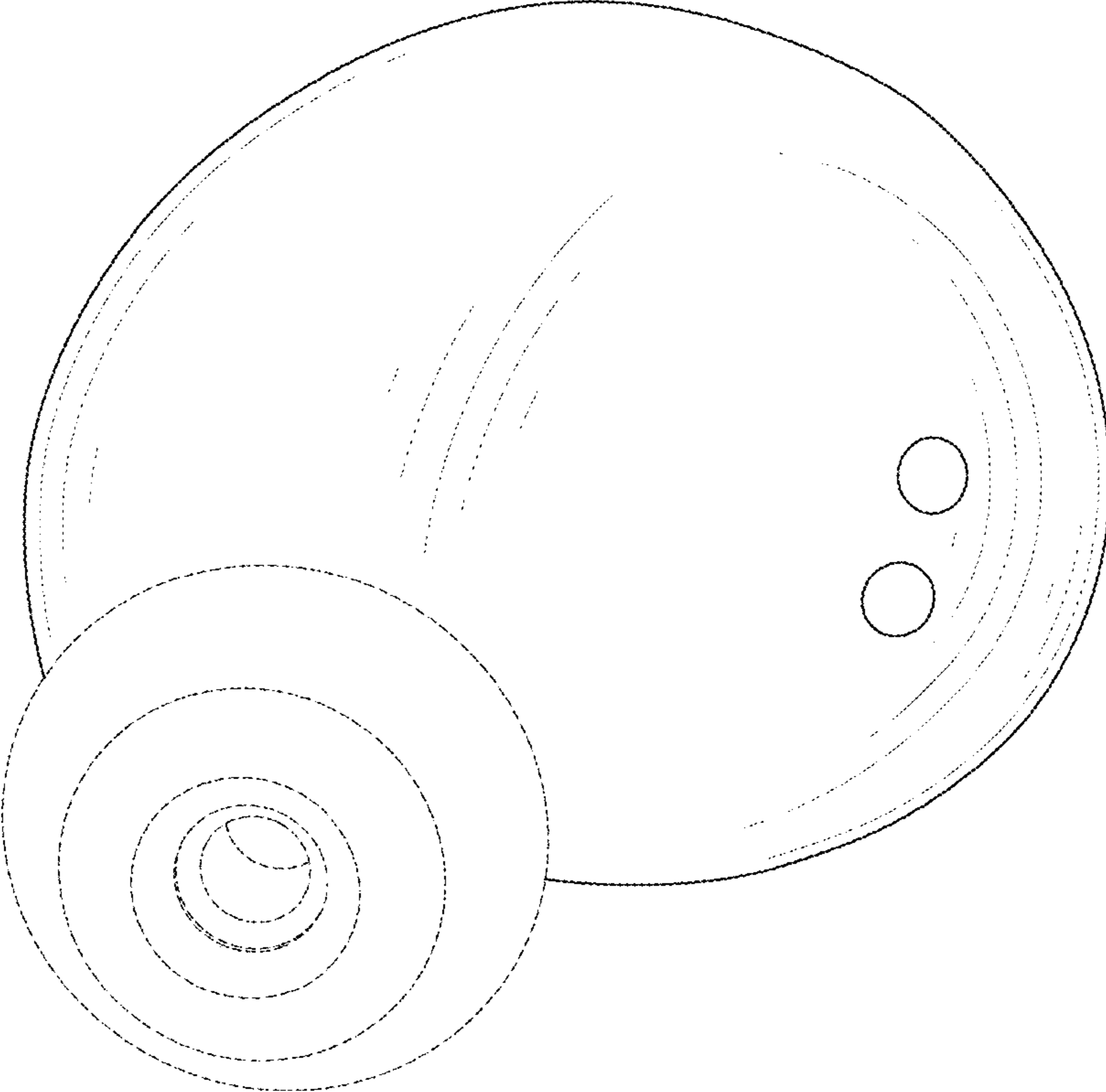


FIG. 3

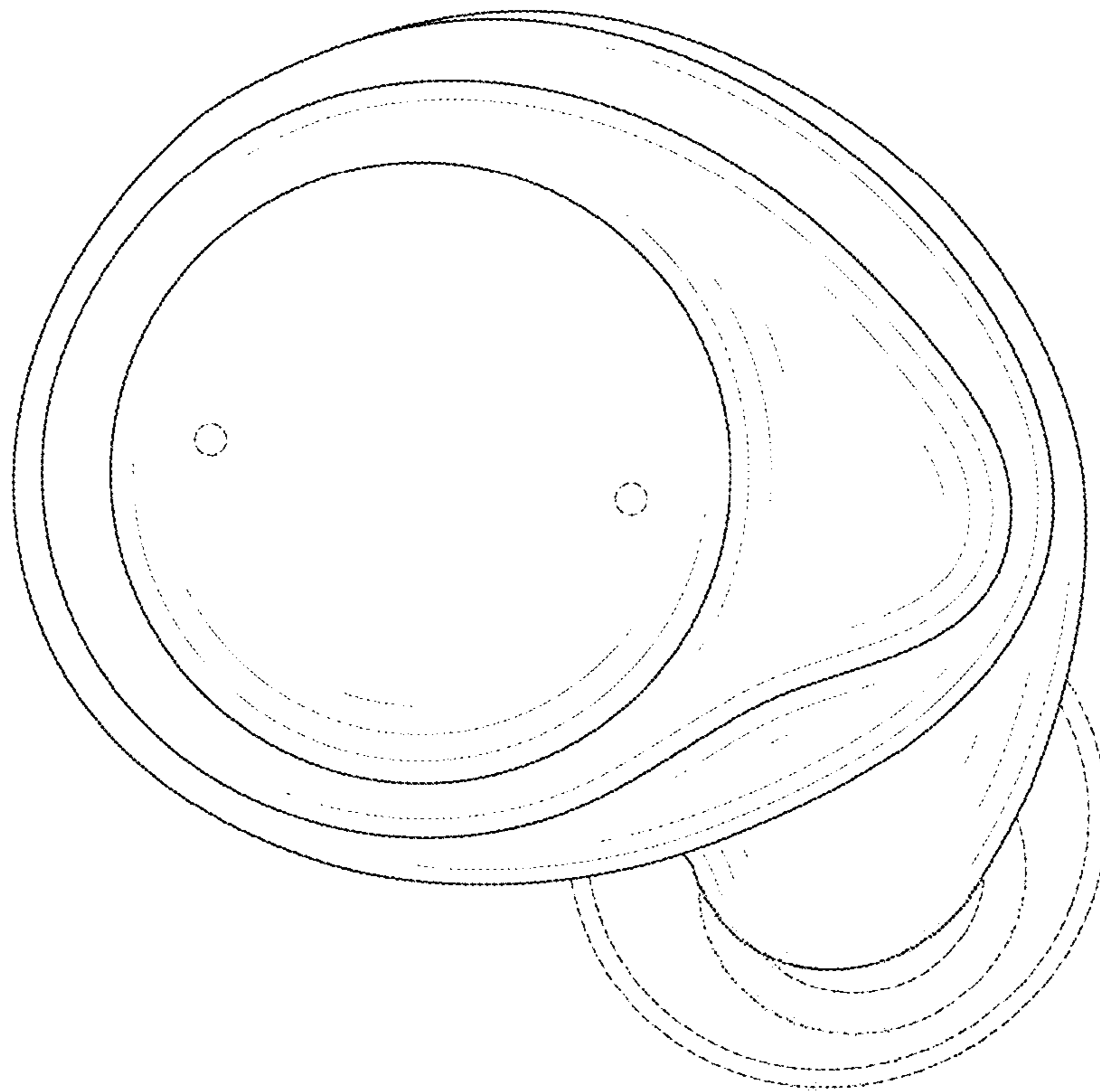


FIG. 4

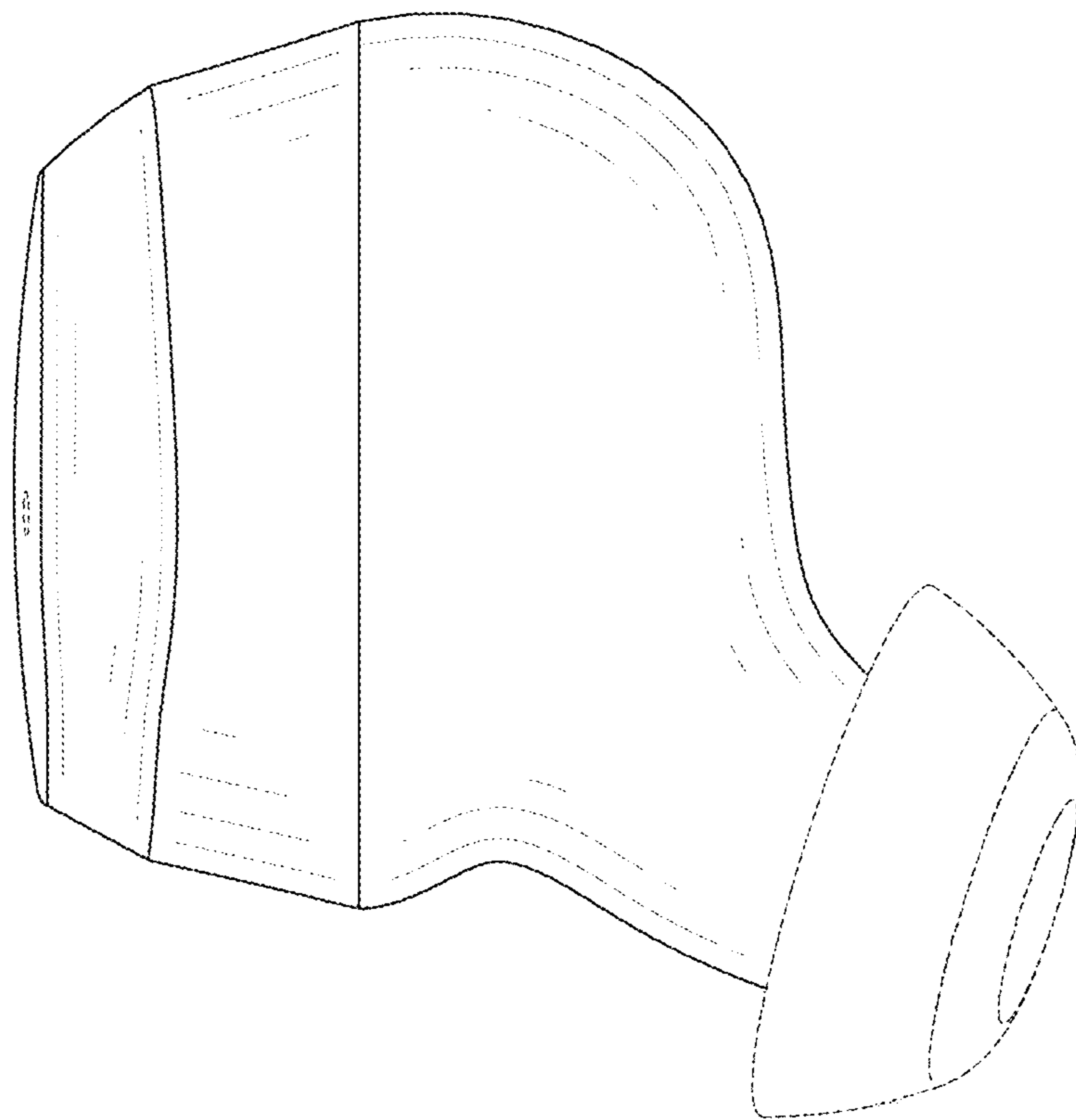


FIG. 5

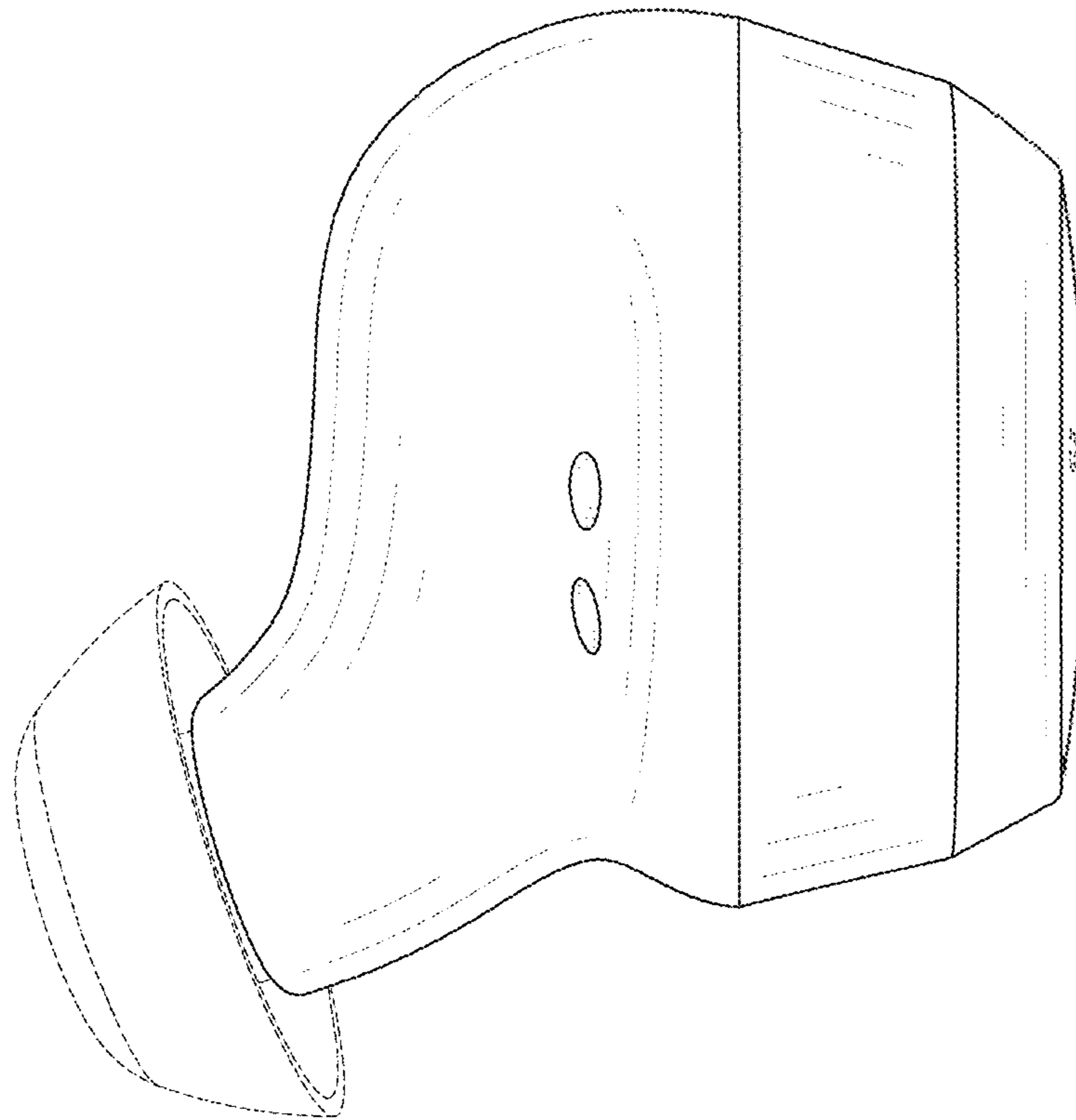


FIG. 6

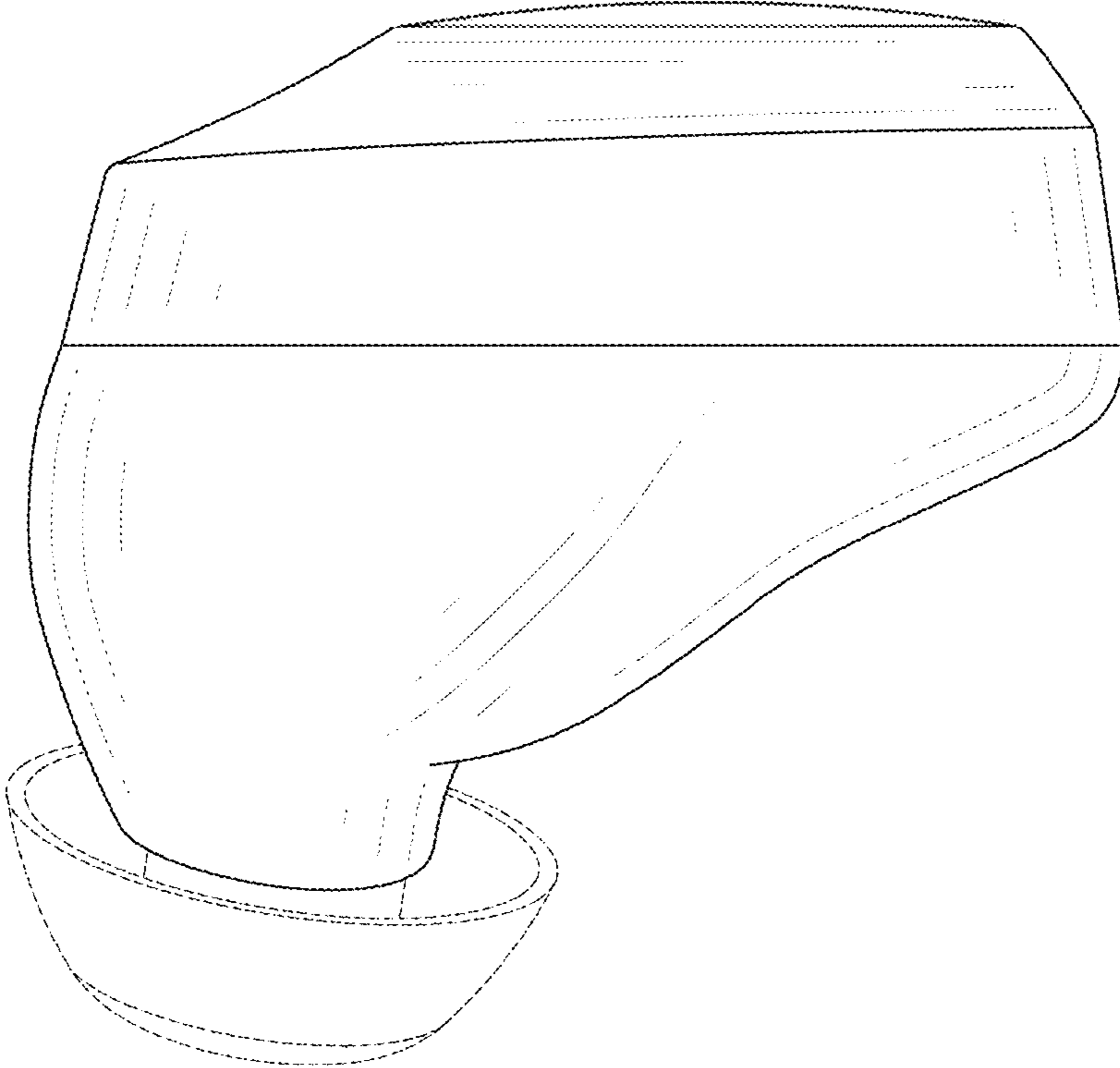


FIG. 7

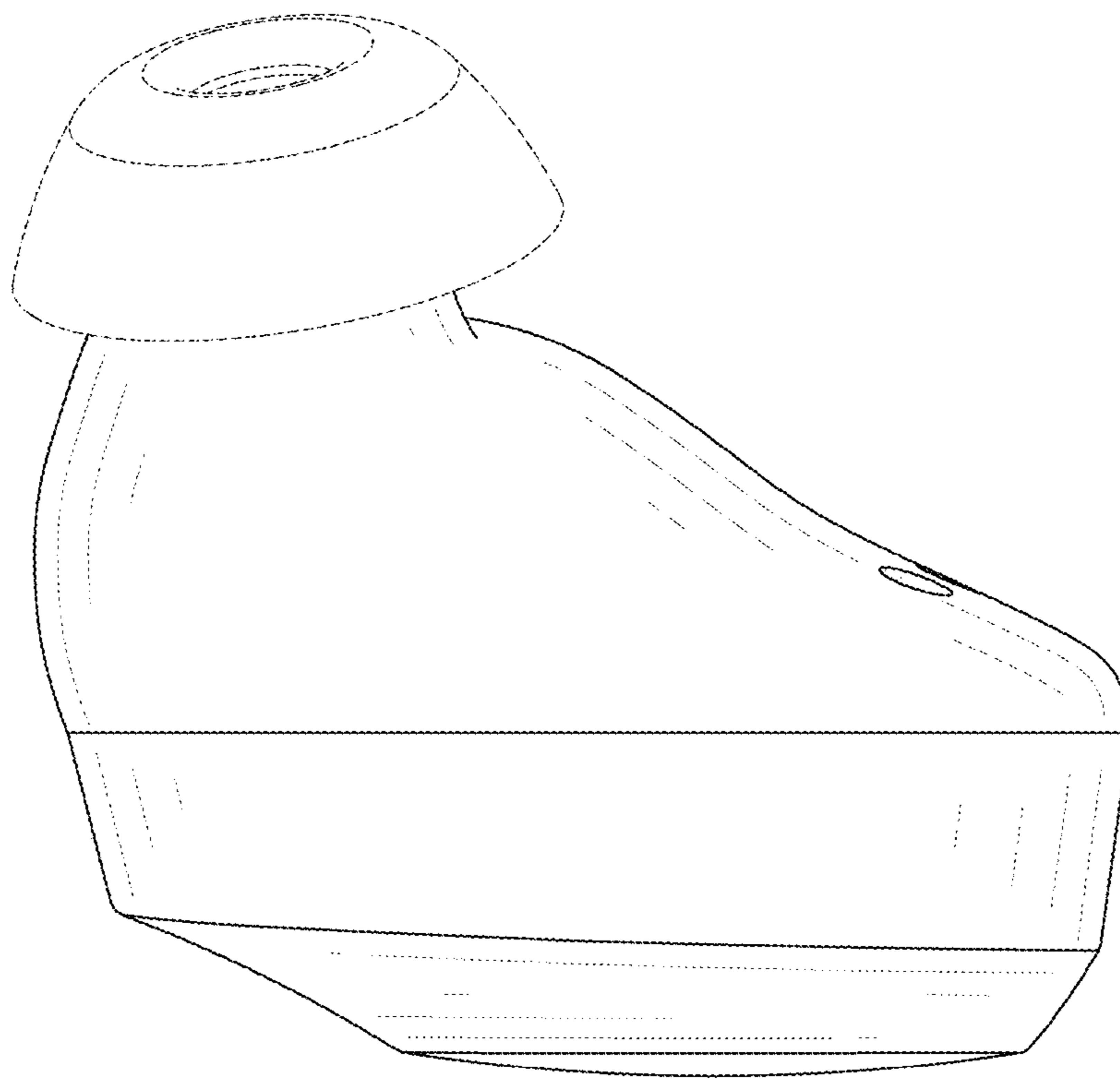


FIG. 8